



## **General Description**

The WSD1216DN22 is the highest performance trench P-Channel MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WSD1216DN22 meet the RoHS and Green Product requirement with full function reliability approved.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

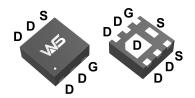
## **Product Summery**

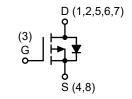
BV <sub>DSS</sub>	R <sub>DSON</sub>	l <sub>D</sub>
-12V	15mΩ	-9.4A

### **Applications**

- High Frequency Point-of-Load Synchronous Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

## **DFN2X2-6S Pin Configuration**





## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
$V_{DS}$	Drain-Source Voltage	-12	V	
$V_{GS}$	Gate-Source Voltage	±8	V	
I <sub>D</sub> @T <sub>c</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ -4.5V <sup>1</sup>	-9.4	А	
I <sub>D</sub> @T <sub>c</sub> =70℃	Continuous Drain Current, V <sub>GS</sub> @ -4.5V <sup>1</sup>	-7.5	Α	
I <sub>DM</sub>	300μS Pulsed Drain Current,V <sub>GS</sub> =-4.5V <sup>2</sup>	-37.5	Α	
P <sub>D</sub> @T <sub>A</sub> =25°C	P <sub>D</sub> @T <sub>A</sub> =25℃ Total Power Dissipation <sup>3</sup>		W	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	$^{\circ}$	
TJ	Operating Junction Temperature Range	-55 to 150	$^{\circ}$	

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient <sup>1</sup>		80	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case <sup>1</sup>		28	°C/W

P-Channel MOSFET

## Electrical Characteristics (TJ=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0 $V$ , $I_D$ =-250 $u$ A	-12			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25℃, I <sub>D</sub> =-1mA		-0.01		V/°C
D	Static Design Courses On Designation as 2	V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-9.4A		15	20	mΩ
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-2.5V , I <sub>D</sub> =-5.9A		20	27	
$V_{GS(th)}$	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> . I <sub>D</sub> =-250uA	-0.4	-0.6	-0.9	٧
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	V <sub>GS</sub> -V <sub>DS</sub> , I <sub>D</sub> 250uA		3.13		mV/℃
	Drain Source Leakage Current	V <sub>DS</sub> =-8V , V <sub>GS</sub> =0V , T <sub>J</sub> =25℃			-1	uA
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =-8V , $V_{GS}$ =0V , $T_J$ =55 $^{\circ}\mathrm{C}$			-5	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = $\pm 8V$ , $V_{DS}$ = $0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-1A		16		S
$R_g$	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2		Ω
Qg	Total Gate Charge (-4.5V)	ite Charge (-4.5V)		15.5		
$Q_{gs}$	Gate-Source Charge	V <sub>DS</sub> =-10V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-9.4A		2.3		nC
$Q_{gd}$	Gate-Drain Charge			4.6		
T <sub>d(on)</sub>	Turn-On Delay Time			7		
Tr	Rise Time	$V_{DD}$ =-10V , $V_{GS}$ =-4.5V , $R_{G}$ =6 $\Omega$		12		20
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =-1A, R <sub>L</sub> =10Ω		21		ns
T <sub>f</sub>	Fall Time			12		
C <sub>iss</sub>	Input Capacitance			1400		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =-10V , V <sub>GS</sub> =0V , f=1MHz		297	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			237		

### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,4</sup>	\/ -\/ -0\/ Force Current			-2.0	А
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			-37.7	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25℃			-1	V
t <sub>rr</sub>	Reverse Recovery Time	I- 0 44 11/11 4004/ . T 05°0		26		nS
Q <sub>rr</sub>	Reverse Recovery Charge	lF=-9.4A,dI/dt=100A/μs , Tյ=25℃		10		nC

## Note:

- 1. The data tested by surface mounted on a 1 inch $^2$  FR-4 board with 2OZ copper, t $\leq$ 10sec.
- 2.The data tested by pulsed , pulse width  $\,\leqq\,$  300us , duty cycle  $\,\leqq\,$  2%
- 4. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



## **Typical Characteristics**

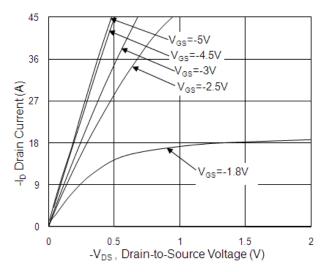


Fig.1 Typical Output Characteristics

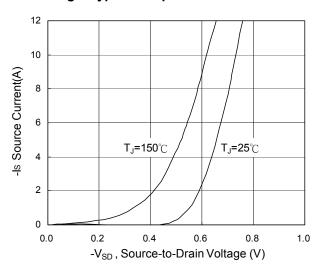


Fig.3 Forward Characteristics Of Reverse

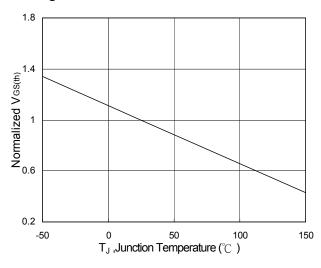


Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

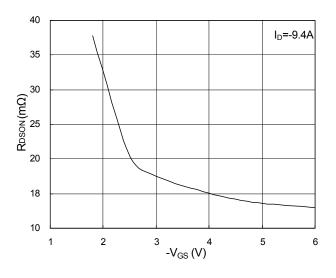


Fig.2 On-Resistance vs. Gate-Source

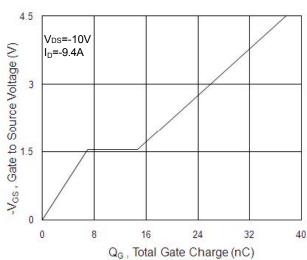


Fig.4 Gate-Charge Characteristics

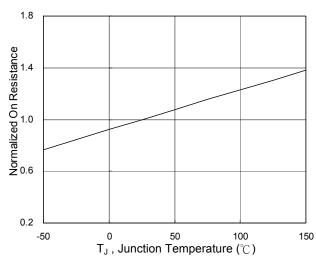
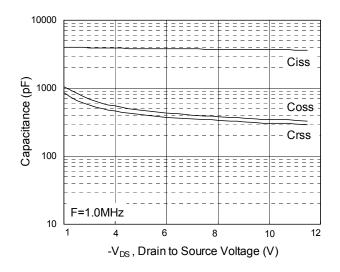


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>





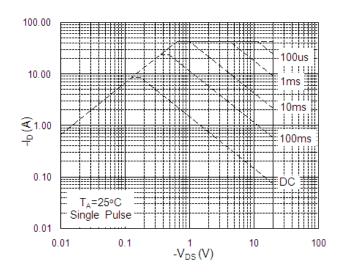


Fig.7 Capacitance

Fig.8 Safe Operating Area

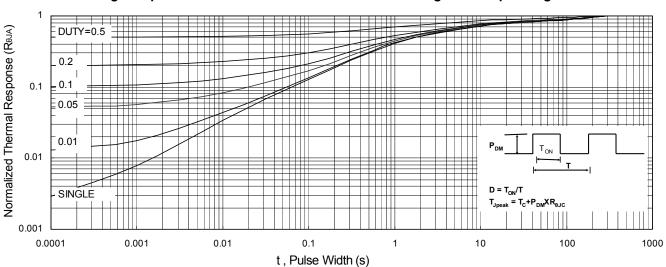
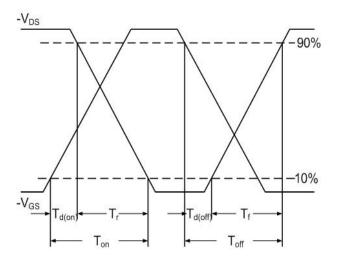
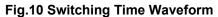


Fig.9 Normalized Maximum Transient Thermal Impedance





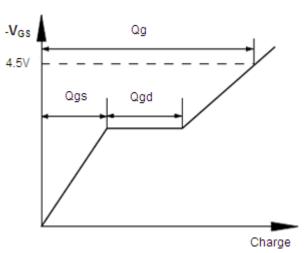
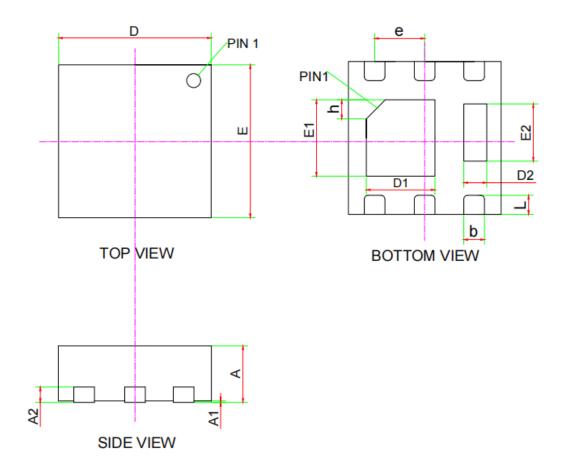


Fig.11 Gate Charge Waveform



# **Packaging information**



SYMBOL	MIN	NOM	MAX	
Α	0.70	0.75	0.80	
A1	0.00	0.02	0.05	
A2	0.18	0.20	0.25	
b	0.20	0.27	0.34	
D	1.95	2.00	2.05	
E	1.95	2.00	2.05	
D1	0.80	0.90	1.00	
E1	0.90	1.00	1.10	
D2	0.20	0.30	0.40	
E2	0.65	0.75	0.85	
L	0.20	0.25	0.35	
h	0.20	0.25	0.30	
е	0.65 BSC			



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